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**Submission Title:** Simple Wireless System Simulation with Characteristics of 3D-Printed THz Metasurfaces

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**Re:** N/A

**Abstract:** Metasurfaces have become crucial in advancing THz technology for development of compact, planar, and lightweight devices. In this work, we have proposed and demonstrated 3D-printed THz metasurfaces by using a 3D printer with digital light processing technique, and simple wireless simulation with S-parameter characteristics of the metasurface devices designed for some variations of beam direction.

**Purpose:** Information document for IEEE 802.15 SC THz

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# Simple Wireless System Simulation with Characteristics of 3D-Printed THz Metasurfaces

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# Motivation and Outline

- Terahertz Metasurface Devices (NECTEC)
  - Technology for development of compact, planar, and lightweight devices
  - 3D-printed metasurfaces with digital light processing technique: faster and cheaper than traditional photolithography
  - Available to vary the beam direction by metasurface design
- Wireless System Simulation (NICT)
  - Basic wireless system simulation using S-parameter characteristics of metasurface devices designed by NECTEC
  - Using frequency bands assigned for IEEE802.15.3d
  - Observing EVM for several beam directions

# Terahertz properties and applications

## THz properties

- Easily passes through non-polar materials.
- Absorbed by polar materials.
- Non-ionizing then safe for human.
- Reflected by metals.
- spectral fingerprints for Bio-molecules

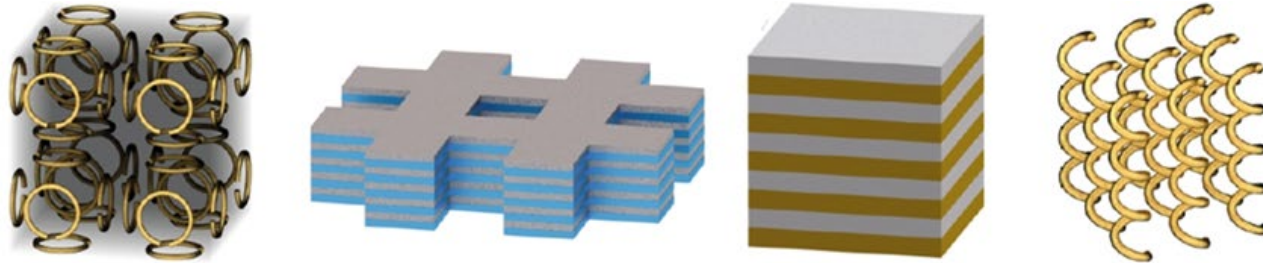
## Terahertz applications

The collage consists of six panels:

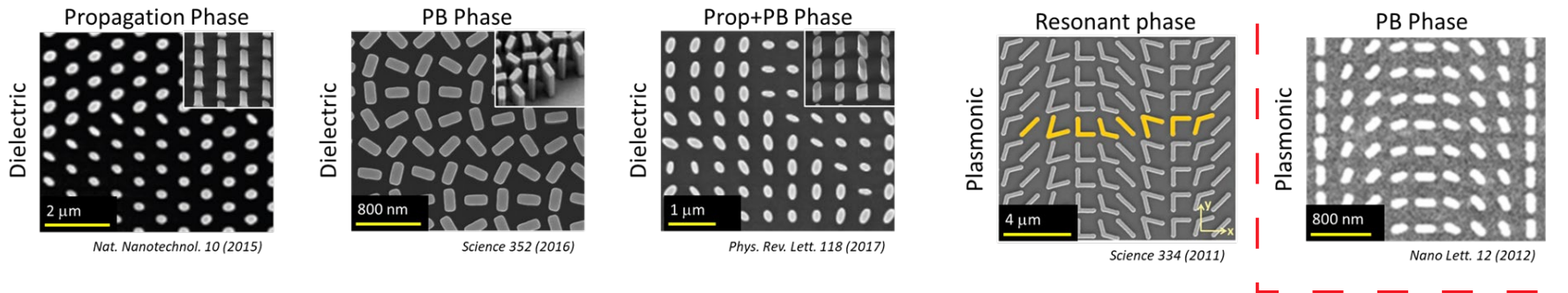
- Security Screening:** Shows 'THz Fingerprints of Explosives' with a graph of frequency vs. absorption and a 'THz Full Body Scanner' image.
- Pharmaceuticals:** Displays various pills and a graph showing the spectral fingerprints of different drugs.
- Communication:** A bar chart titled 'SPEED COMPARISON' showing data rates for 3G (384 kbps), 4G (100 Mbps), WiFi (300 Mbps), 5G (1-10 Gbps), and THz (100 Gbps).
- Medical Applications:** Includes images of 'Skin Cancer' and 'Tooth Cavity' with corresponding THz spectra.
- Food & Agriculture:** Shows 'Mushrooms Measurement', 'Foreign Body Detection', and 'Seed and Grain Quality Inspection' with associated THz spectra and images.
- Industrial Inspection:** Illustrates 'Quality Control' and 'Defect Detection' in industrial settings using THz waves.

# What are Metasurfaces?

## Metamaterial

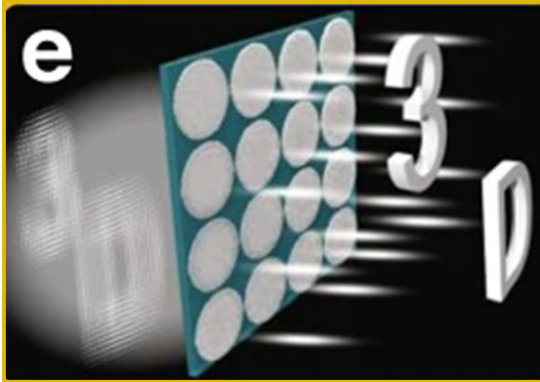


## Metasurface

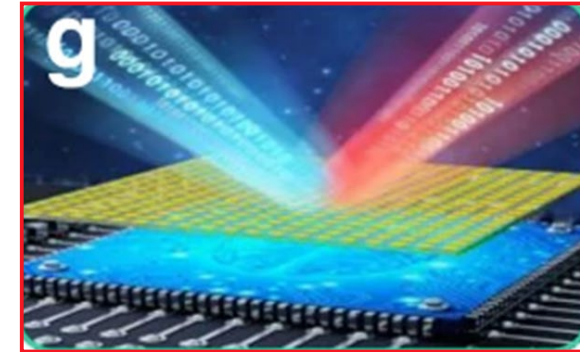


# Metasurfaces applications

## Imaging systems



## Radar systems

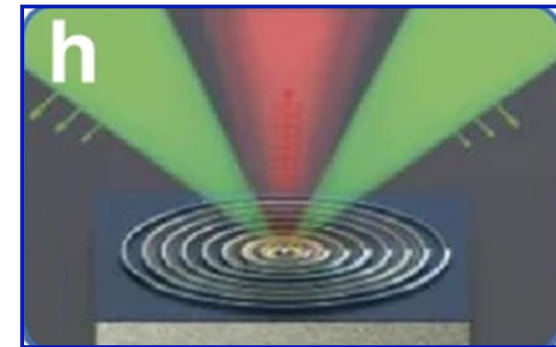


## Metasurfaces applications

## Communication systems

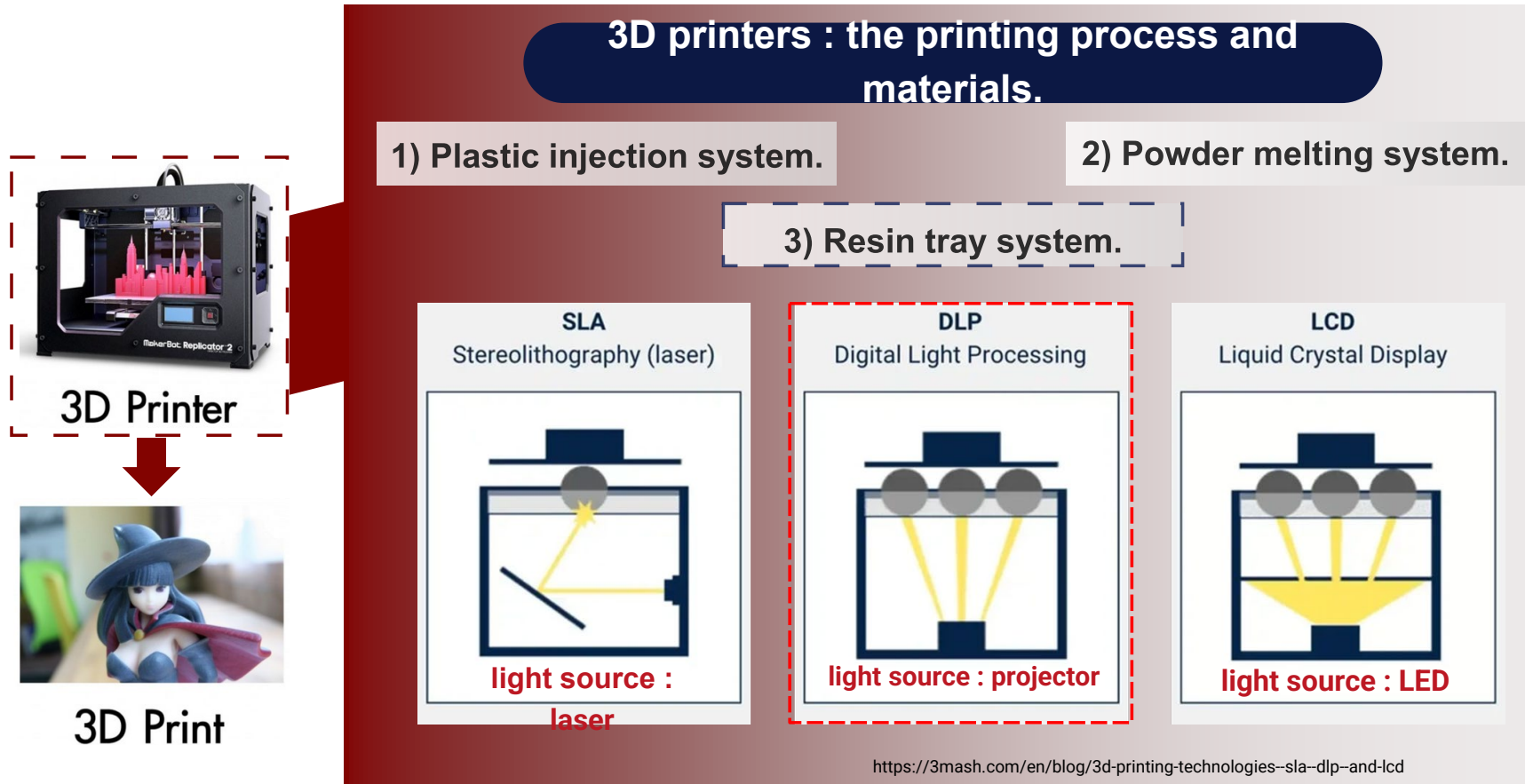


## Quantum optics



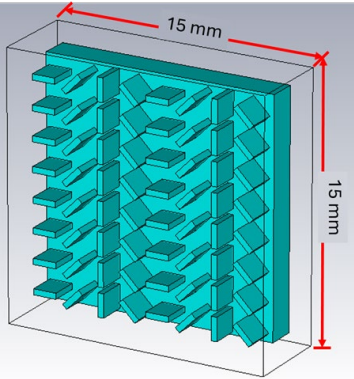
ref.: <https://www.nature.com/articles/s41377-023-01218-y>

# What is 3D Printing



<https://www.print3dd.com/what-is-3d-printer/?srsltid=AfmBOopLFWxR2opd1IKYka63-gAHktHCMtbyK8uQoviZxOh3dpclwVY0>

# 3D printed metasurface device

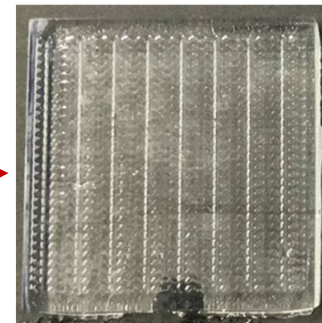


3D model

## Printing conditions

**Fix parameters :** Phrozen Sonic Mini 4K  
Resione G217

**Vary parameters :** Printing speeds from  
30, 90, 120, 150  
and 180 mm/ min.



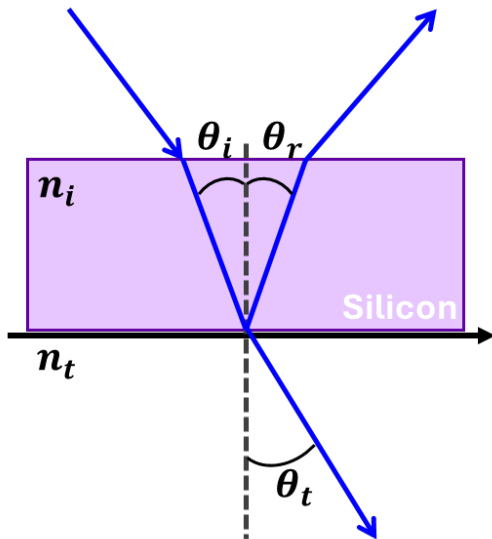
THz metasurfaces  
sample



# Design and methods

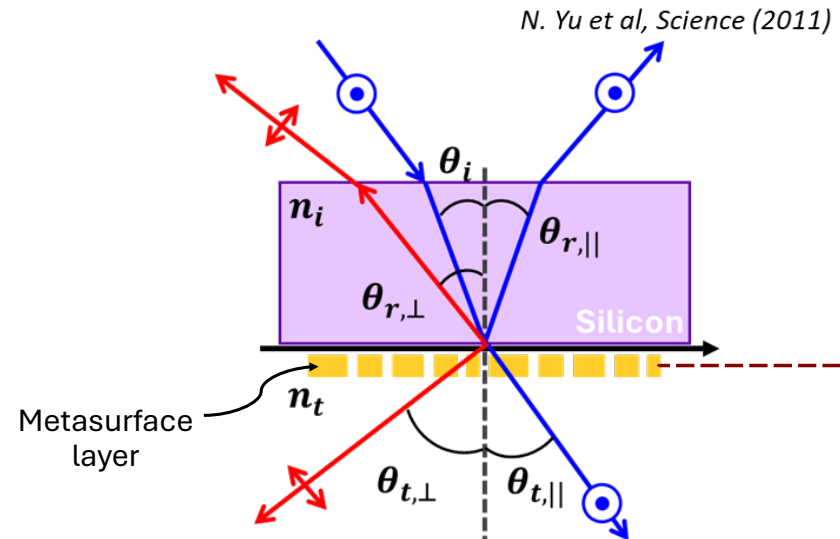
## Traditional optics

$$n_t \sin(\theta_t) - n_i \sin(\theta_i) = 0 \dots (1)$$



## Metasurface optics

$$n_t \sin(\theta_t) - n_i \sin(\theta_i) = \frac{\lambda_0}{2\pi} \frac{d\Phi}{dx} \dots (2)$$



# Design and methods

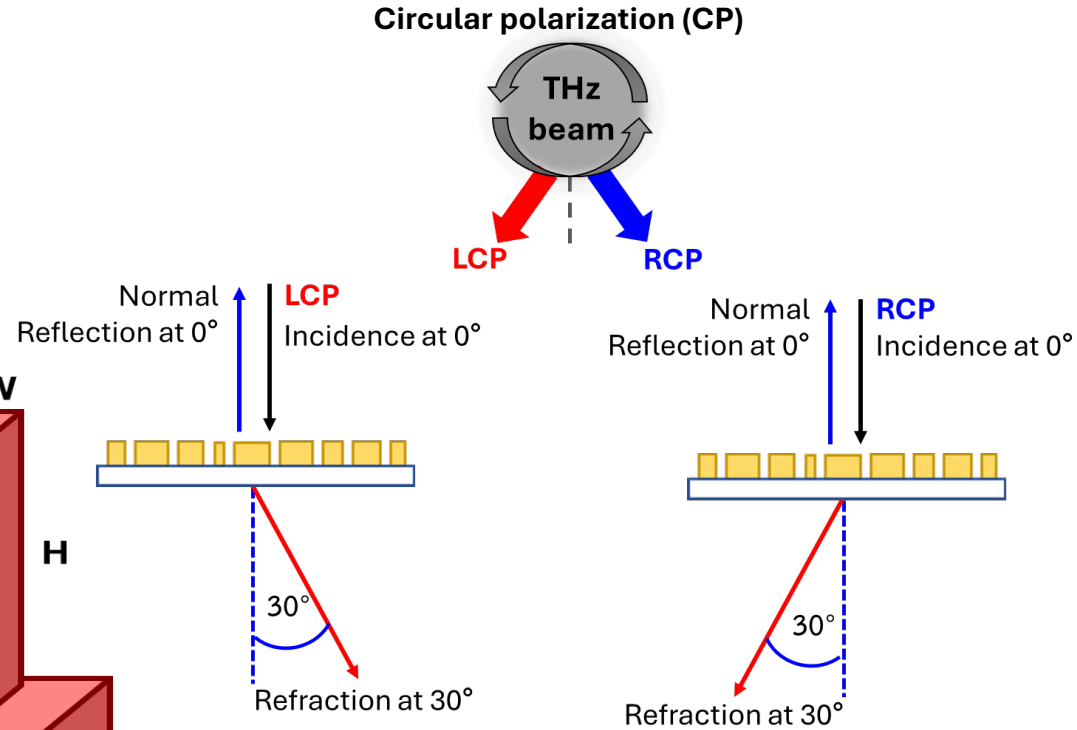
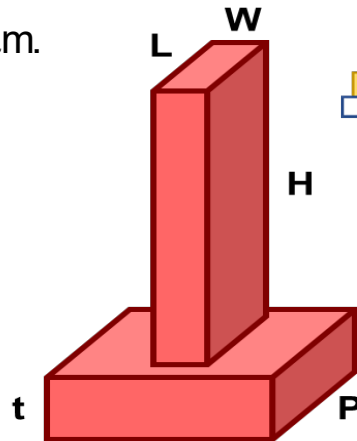
$$d\varphi = \frac{2\pi}{\lambda_0} (\sin \theta_r - \sin \theta_i) dx$$

$dx$  is the size of a unit cell or  $P$ .

$\theta_i$  is an incident angle =  $0^\circ$

$\theta_r$  is a refraction angle =  $30^\circ$

$\lambda_0$  is a THz wavelength =  $1000 \mu\text{m}$ .

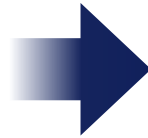


# Design and methods

**TDS**

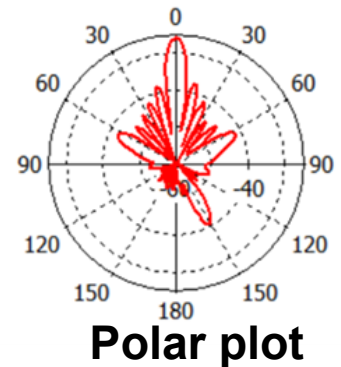
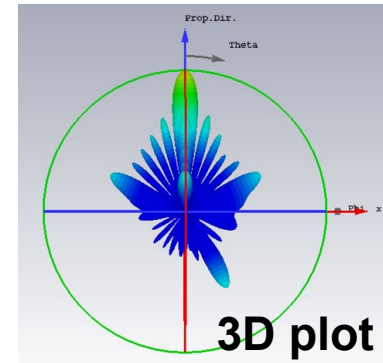
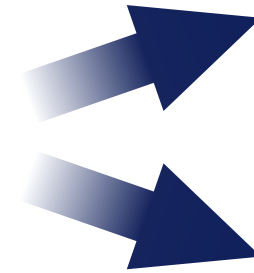


Resin Properties :  
 $n = 1.7$  ,  $\epsilon = 2.89$

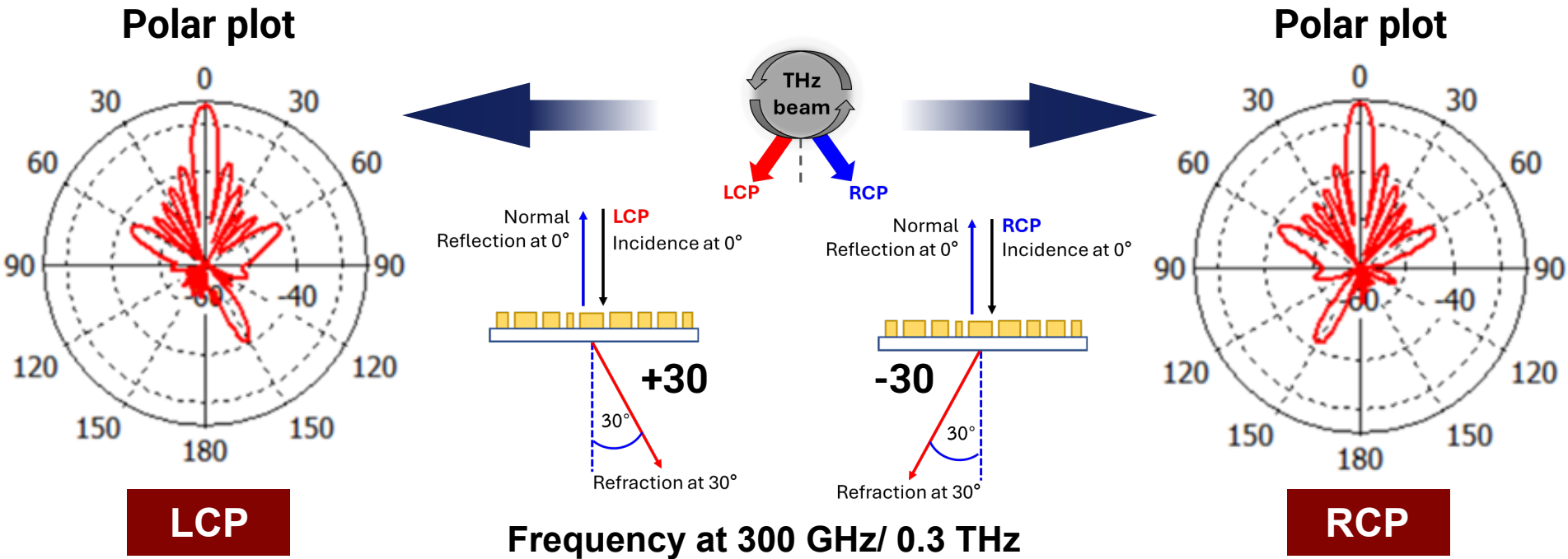


EM Simulator

Incident : LCP , RCP  
Frequency (f) : 300 GHz

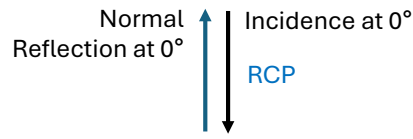


# Example of simulation result

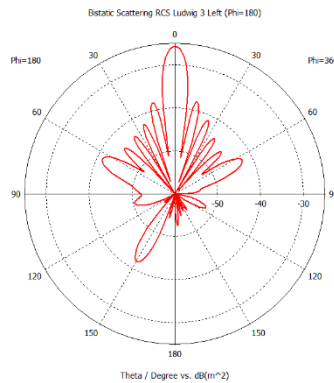


# Variation of beam direction

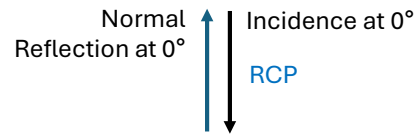
150°



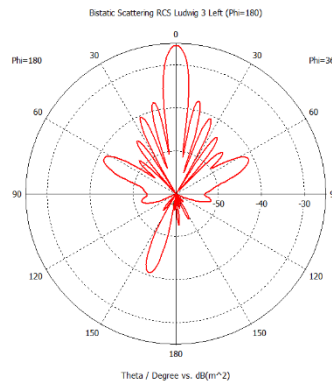
Refraction at 30° or 150°



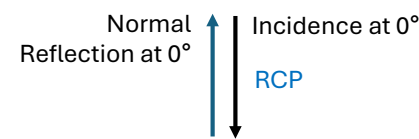
160°



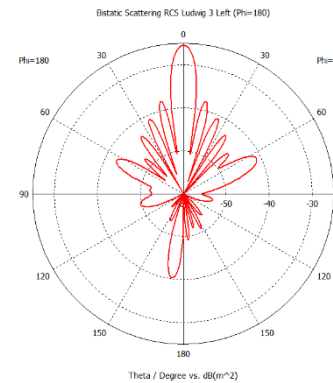
Refraction at 20° or 160°



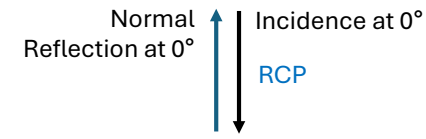
170°



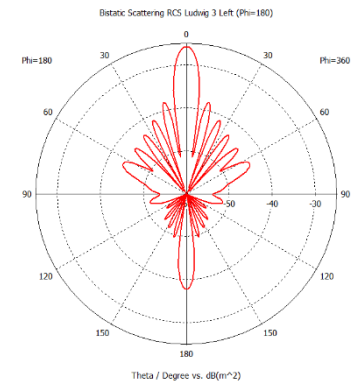
Refraction at 10° or 170°



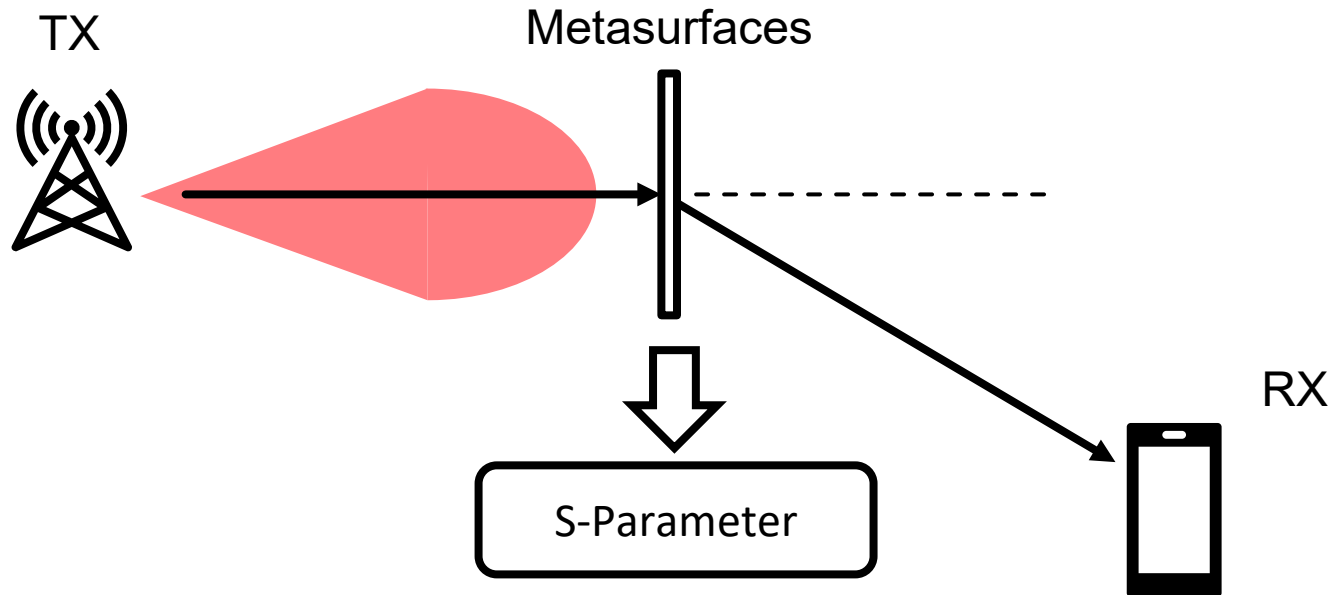
180°



Refraction at 0° or 180°



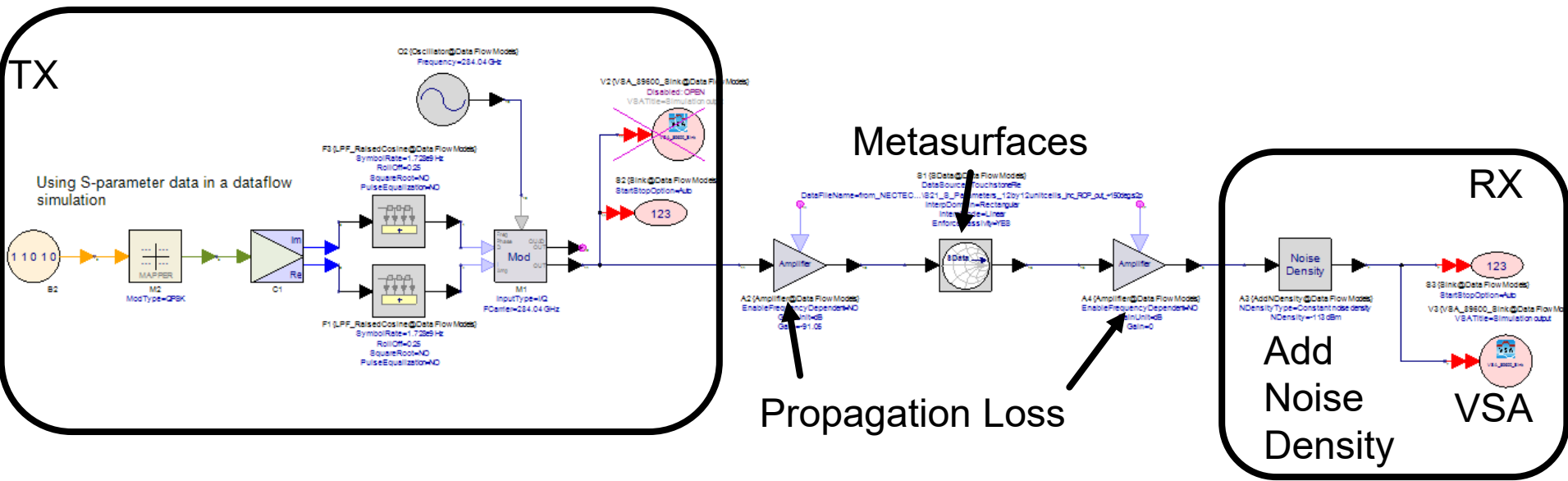
# Wireless system simulation



# Condition of the simulation

- Beam direction: +150deg, +160deg, +170deg, +180deg
- Bandwidth: 2.16 GHz, Center freq: 284.04 GHz
- Bandwidth: 8.64 GHz, Center freq: 282.96 GHz
- Mod. Type: QPSK
- TX-Metasurfaces: 1.5m ,Loss: 85 dB
- Metasurfaces-RX : 1.5m ,Loss: 85 dB
- TX PWR: 20dBm
- Adding Noise Density: -203 dBm/Hz

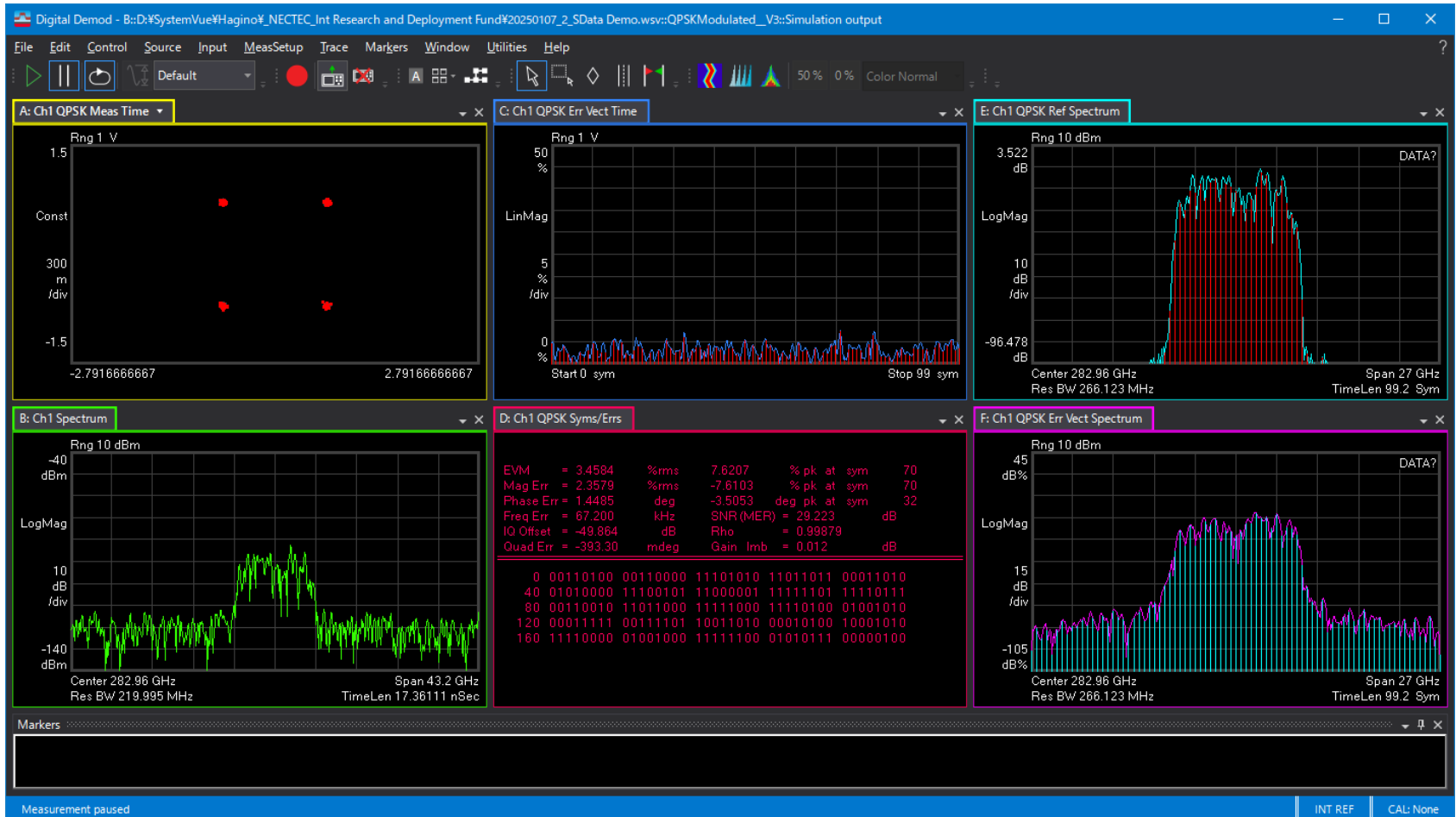
# Schematic of the simulation



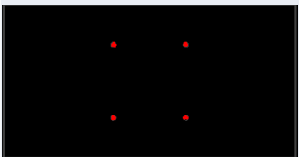
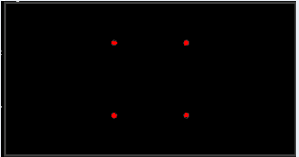
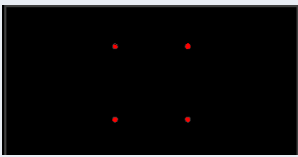
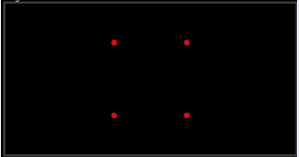
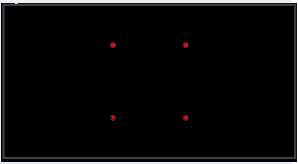
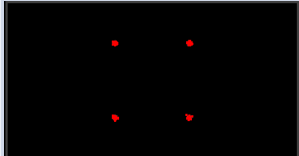
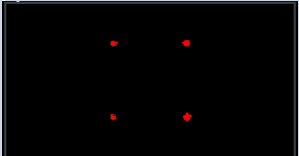
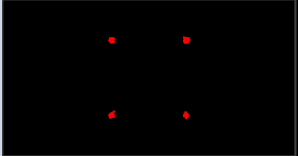
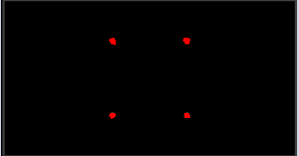
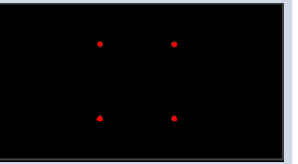


# Example of the simulation results

Bandwidth: 8.64 GHz, Beam direction: 150°



# Summary of the constellations

Bandwidth (GHz)	Beam direction				wo/ Metasurfaces
	150deg	160deg	170deg	180deg	
2.16					
8.64					

# Summary of EVM

		EVM [%rms]					
Bandwidth (GHz)		Beam direction				wo/ Metasurfaces	
		150deg	160deg	170deg	180deg		
2.16	Max.	2.3	2.0	2.1	2.0	1.3	
	Min.	1.6	1.5	1.5	1.5	0.9	
8.64	Max.	4.1	3.6	3.4	3.4	2.3	
	Min.	3.5	3.0	3.1	3.0	1.9	

- When the metasurface devices are inserted, EVM increases approximately 0.6% in 2.16 GHz bandwidth and approximately 1.2% in 8.64 GHz bandwidth.
- There is little change in EVM due to the difference in the beam direction, but the EVM deteriorates slightly only at 150 degrees.
- Overall, EVM characteristics are almost consistent with brief expectations.

# Conclusion

- Terahertz Metasurface Devices (NECTEC)
  - Technology for development of compact, planar, and lightweight devices
  - 3D-printed metasurfaces with digital light processing technique: faster and cheaper than traditional photolithography
  - Available to vary the beam direction by metasurface design
- Wireless System Simulation (NICT)
  - Basic wireless system simulation using S-parameter characteristics of metasurface devices designed by NECTEC
  - Using frequency bands assigned for IEEE802.15.3d
  - Observing EVM for several beam directions

Thank you!